

Updated Search History (6pp.; 2/21/4) *yz*

L Number	Hits	Search Text	DB	Time stamp
1	1	((257/656) or (257/657) or (257/458) or (257/619) or (257/620) or (257/621) or (257/622) or (257/623) or (438/59) or (438/167) or (438/622)).CCLS.) and (pin adj diode rectifier adj diode) and mesa near4 (location located positioned position) near4 (edge centre center)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/21 13:46
2	3	(pin adj diode rectifier adj diode) and mesa near4 (location located positioned position) near4 (edge centre center)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/21 13:46
-	42	spitz.in. near2 richard.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/21 11:16
-	0	rectifier adj diode and clock adj (frequency frequencies) and switching adj (rate time) and thickness.ti,ab,clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 17:09
-	4	rectifier adj diode and clock adj (frequency frequencies) and switching adj (rate time) and thickness	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 17:10
-	433	257/101	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 17:12
-	354	257/104	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 17:19
-	3080	rectifier adj diode.ti,ab,clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 17:20
-	86	rectifier adj diode.ti,ab,clm. and thickness	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 17:40
-	2	914404.ap.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:26
-	2	de-4135258\$-\$..did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 21:12
-	3	("4220963").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:30
-	0	("fr-2319972\$-\$..did.").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:30

-	0	("fr-2319972\$-\$\$.did. ").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:30
-	0	fr-02319972\$-\$\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:31
-	1	fr-2319972\$-\$\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:31
-	64	rectifier adj diode.ti,ab,clm. and 257/\$9.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 21:20
-	272	PIN adj diode.ti,ab,clm. and 257/\$9.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 21:28
-	510	((257/656) or (257/657)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 21:28
-	95	((257/656) or (257/657)).CCLS.) and 438/\$9.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 21:29
-	0	metallization near5 PIN adj diode near12 wafer near6 cutting	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:27
-	0	street near12 dicing and metallization near12 backside	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:28
-	7	street and (dice dicing) and metallization near12 backside	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:29
-	2	("5689091").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:30
-	20415	(cut cutting dice dicing) near6 wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:30
-	96	(cut cutting dice dicing) near6 wafer and (metallization metallisation metallize metallise) near6 (top upper front top-side front-side) and (metallization metallisation metallise metallize) near6 (bottom lower back backside back-side)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:32

-	50	(cut cutting dice dicing) near6 wafer and (metallization metallisation metallize metallise) near6 (top upper front top-side front-side) and (metallization metallisation metallise metallize) near6 (bottom lower back backside back-side) and method.clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:33
-	15	(cut cutting dice dicing) near6 wafer and (metallization metallisation metallize metallise) near6 (top upper front top-side front-side) and (metallization metallisation metallise metallize) near6 (bottom lower back backside back-side) and (method near6 (metal metallizing metallization)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:37
-	0	((method process) near12 (metallization metallizing metallising metallisation) near12 (cutting dicing cut dice)).ti,ab,clm. and street	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:38
-	36	((method process) near12 (metallization metallizing metallising metallisation) near12 (cutting dicing cut dice)).ti,ab,clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:38
-	14	((method process) near12 (metallization metallizing metallising metallisation) near12 (cutting dicing cut dice)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:43
-	0	street near12 dicing near12 metallization	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:43
-	84	dicing near12 metallization	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 09:43
-	7	dicing near12 metallization.clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 10:48
-	5891	((257/656) or (257/657) or (257/458) or (257/619) or (257/620) or (257/621) or (257/622) or (257/623) or (438/59) or (438/167) or (438/622)).CCLS.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/09/30 10:57
-	161	((257/656) or (257/657) or (257/458) or (257/619) or (257/620) or (257/621) or (257/622) or (257/623) or (438/59) or (438/167) or (438/622)).CCLS.) and (pin adj diode rectifier adj diode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/21 12:17
-	6	252556.ap.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 15:25
-	2	de-4135258\$-\$\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/21 11:20
-	1	fr-2319972\$-\$\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/21 11:18

-	0	ge-4291183\$-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/21 11:20
-	0	de-4291183\$-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/21 11:21
-	0	de-429183\$-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/21 11:21
-	0	de-4291183\$-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/21 11:27
-	3	("4220963").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/21 11:28
-	1	de-3633161\$-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/21 11:30
-	2	de-19845569\$-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/21 11:30

-	161	(US-RE32893-\$ or US-4812895-\$ or US-4811080-\$ or US-4805084-\$ or US-4754312-\$ or US-4751201-\$ or US-4738933-\$ or US-4716449-\$ or US-4692998-\$ or US-4680085-\$ or US-4675628-\$ or US-4660008-\$ or US-4636829-\$ or US-4571559-\$ or US-4447746-\$ or US-4412239-\$ or US-4367483-\$ or US-4344047-\$ or US-4301429-\$ or US-4275362-\$ or US-4240088-\$ or US-4183034-\$ or US-4182965-\$ or US-4141136-\$ or US-4137543-\$ or US-4097890-\$).did. or (US-4092663-\$ or US-4064620-\$ or US-4045252-\$ or US-4011016-\$ or US-3982267-\$ or US-3959794-\$ or US-3916351-\$ or US-3792321-\$ or US-3677280-\$ or US-3676716-\$ or US-3579815-\$ or US-4889826-\$ or US-4885622-\$ or US-4847210-\$ or US-4825081-\$ or US-5670817-\$ or US-5594237-\$ or US-5557114-\$ or US-5504365-\$ or US-5465002-\$ or US-5426312-\$ or US-5401999-\$ or US-5386137-\$ or US-5360990-\$ or US-5355013-\$ or US-5343070-\$ or US-5294843-\$).did. or (US-5280189-\$ or US-5237197-\$ or US-5225706-\$ or US-5185272-\$ or US-5181083-\$ or US-5159296-\$ or US-5107318-\$ or US-5097306-\$ or US-5097120-\$ or US-5073809-\$ or US-5063428-\$ or US-5051803-\$ or US-5051789-\$ or US-5049971-\$ or US-4910570-\$ or US-4907054-\$ or US-4904607-\$ or US-4891521-\$ or US-4994883-\$ or US-5008590-\$ or US-4899204-\$ or US-4916305-\$ or US-4926231-\$ or US-5920091-\$ or US-5920065-\$ or US-5886374-\$ or US-5841178-\$).did. or (US-5798558-\$ or US-5789276-\$ or US-5773858-\$ or US-6288435-\$ or US-6300648-\$ or US-6303979-\$ or US-6342720-\$ or US-6369436-\$ or US-6384460-\$ or US-6388306-\$ or US-6396118-\$ or US-6043549-\$ or US-6049109-\$ or US-6054747-\$ or US-6057569-\$ or US-6069022-\$ or US-6072224-\$ or US-6075275-\$ or US-6081020-\$ or US-6104046-\$ or US-6111300-\$ or US-5923071-\$ or US-6018187-\$ or US-6027956-\$ or US-5923049-\$ or US-5977611-\$ or US-6114739-\$).did. or (US-6153921-\$ or US-6175142-\$ or US-6198147-\$ or US-6229191-\$ or US-6229192-\$ or US-6281561-\$ or US-5998806-\$ or US-6593635-\$ or US-6593636-\$ or US-6008527-\$ or US-6426547-\$ or US-6429498-\$ or US-6429500-\$ or US-6465289-\$ or US-6485998-\$ or US-6514785-\$ or US-6524900-\$ or US-6538299-\$ or US-6566724-\$ or US-6573128-\$).did. or (US-20030111704-\$ or US-20030116782-\$ or US-20010016377-\$ or US-20010020704-\$ or US-20020070388-\$ or US-20020121678-\$ or US-20020130380-\$ or US-20030062584-\$ or US-20030089958-\$).did. or (EP-581422-\$ or EP-505942-\$ or EP-485059-\$ or EP-452801-\$ or DE-3712864-\$ or GB-2168528-\$ or DE-3435464-\$ or EP-103138-\$).did. or (JP-63156355-\$ or JP-61125155-\$ or JP-60198870-\$ or JP-60081873-\$ or JP-59058873-\$ or JP-59035402-\$ or JP-57045284-\$ or	USPAT; US-PGPUB; EPO; JPO	2004/02/21 12:06
Search History	2/21/04 7:41:19 PM	Page 45		
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-	2	((257/656) or (257/657) or (257/458) or (257/619) or (257/620) or (257/621) or (257/622) or (257/623) or (438/59) or (438/167) or (438/622)).CCLS.) and (pin adj diode rectifier adj diode) and edge near4 (cut pit depression)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/21 12:22
-	5	((257/656) or (257/657) or (257/458) or (257/619) or (257/620) or (257/621) or (257/622) or (257/623) or (438/59) or (438/167) or (438/622)).CCLS.) and (pin adj diode rectifier adj diode) and mesa near4 pin adj diode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/21 12:23
-	0	((257/656) or (257/657) or (257/458) or (257/619) or (257/620) or (257/621) or (257/622) or (257/623) or (438/59) or (438/167) or (438/622)).CCLS.) and (pin adj diode rectifier adj diode) and mesa near4 pin adj diode and (pit cut depression)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/21 12:23
-	2	((257/656) or (257/657) or (257/458) or (257/619) or (257/620) or (257/621) or (257/622) or (257/623) or (438/59) or (438/167) or (438/622)).CCLS.) and (pin adj diode rectifier adj diode) and mesa near4 pin adj diode and (edge interior)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/21 13:43